

MIP2L30MS

Silicon MOS FET type integrated circuit

■ Features

- Reducing the average noise
Adding a frequency jitter function to MIP2E/3E* series to dramatically reduce the average noise and simplify EMI parts
- Stabilization of maximum electric power by input correction
Correcting the input voltage dependency of I LIMIT reduces the input voltage dependency of maximum output current
- Overheating protection function
Changed from stopping in latch mode to self reset type
- Protecting function
Overload protection, overheat protection

■ Applications

- Flat-screen TV, audio and others

■ Package

- Code
DIP-7
- Pin Name

1. SOURCE	5. DRAIN
2. SOURCE	6. —
3. SOURCE	7. SOURCE
4. CONTROL	8. SOURCE

■ Marking Symbol: MIP2L3

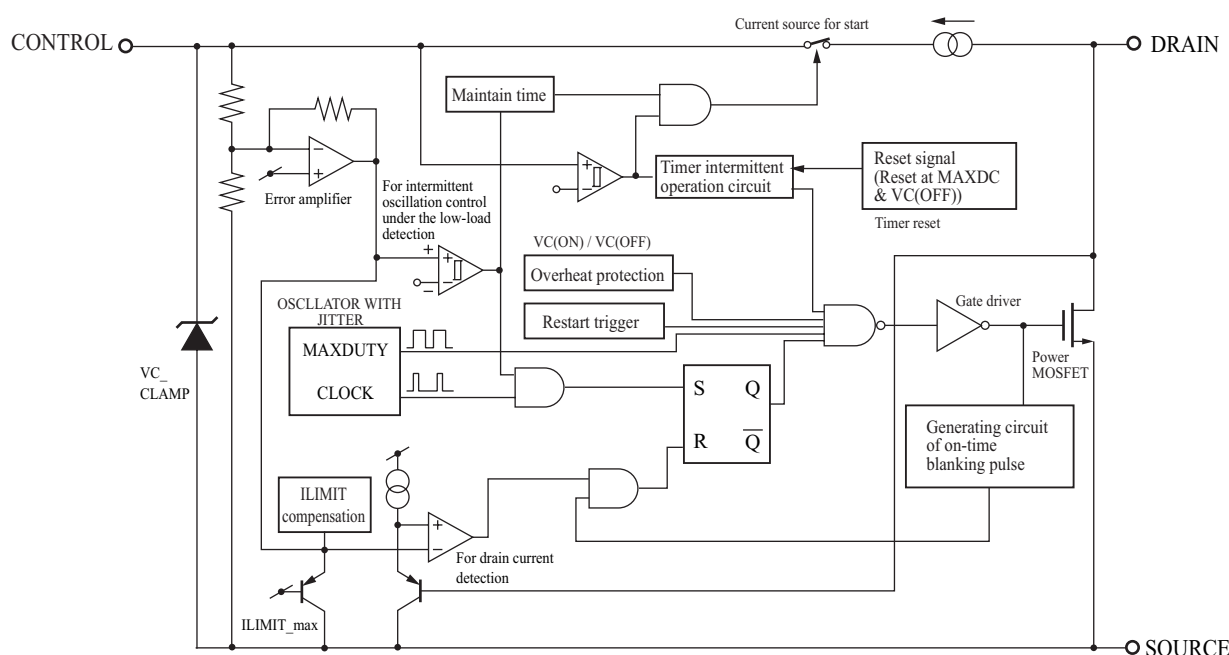
■ Absolute Maximum Ratings $T_a = 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$

Parameter	Symbol	Rating	Unit
DRAIN voltage	VD	-0.3 to +700	V
CONTROL voltage	VC	-0.3 to +8	V
Output peak current *	IDP	1.9	A
Junction temperature	Tj	-30 to +125	°C
Channel temperature	Tch	-30 to +150	°C
Storage temperature	Tstg	-55 to +150	°C

Note) *: The guarantee within the following pulse width.

Leading edge blanking delay + Current limit delay $t_{on}(\text{BLK}) + t_d(\text{OCL})$

■ Block Diagram



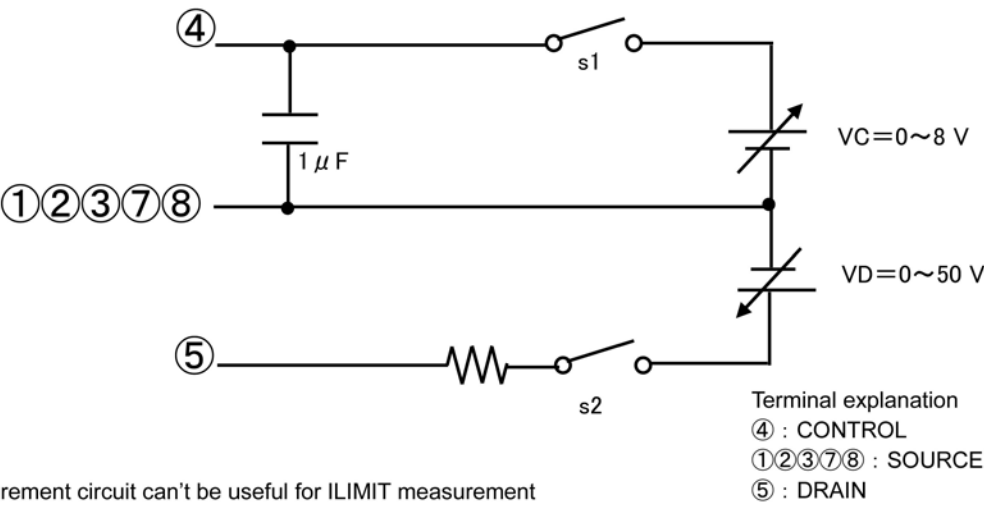
■ Electrical Characteristics $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Control functions						
Output frequency	fosc	$VC = VC(\text{CNT}) - 0.2 \text{ V}$, $VD = 5 \text{ V}$	92	100	108	kHz
Jitter frequency deviation	Δf	$VC = VC(\text{CNT}) - 0.2 \text{ V}$, $VD = 5 \text{ V}$ * Fig. 5		5.5		kHz
Jitter frequency modulation rate *	fM	$VC = VC(\text{CNT}) - 0.2 \text{ V}$, $VD = 5 \text{ V}$ * Fig. 5		270		Hz
Maximum duty cycle	MAXDC	$VC = VC(\text{CNT}) - 0.2 \text{ V}$, $VD = 5 \text{ V}$	50	53	56	%
PWM gain *	GPWM	$VC = VC(\text{CNT})$		12.5		dB
Before auto-restart current	IC(SB)1	$VC < VC(\text{ON})$, $VD = 5 \text{ V}$	0.2	0.5	0.8	mA
After off-state current	IC(SB)2	$VC > VC(\text{CNT})$, $VD = 5 \text{ V}$	0.2	0.5	0.8	mA
Operating current	IC(OP)	$VC = VC(\text{CNT}) - 0.2 \text{ V}$, $VD = 5 \text{ V}$	0.2	0.6	1.0	mA
Auto-restart threshold voltage	VC(ON)	$VD = 5 \text{ V}$	5.75	6.25	6.75	V
UV lockout threshold voltage	VC(OFF)	$VD = 5 \text{ V}$	4.35	4.8	5.25	V
Auto-restart maintain voltage	VC_m	$S1 = \text{OPEN}$	4.95	5.45	5.95	V
Auto-restart maintain time	Tm	$S1 = \text{OPEN}$		45		ms
Auto-restart hysteresis voltage	ΔVC	$VC(\text{ON}) - VC(\text{OFF})$	1.05	1.45	1.85	V
Control clamp voltage	VC(CLP)	$IC = 3 \text{ mA}$	6.2	6.8	7.4	V
Auto-restart duty cycle	TSW/TTIM	$S1 = \text{OPEN}$ * Fig. 4		12		%
Auto-restart frequency	fTIM	$S1 = \text{OPEN}$ * Fig. 4		2.6		Hz
Control pin charging current	IC(CHG)1	$VC = 0 \text{ V}$, $VD = 50 \text{ V}$	-13.1	-8.3	-5.6	mA
	IC(CHG)2	$VC = 5 \text{ V}$, $VD = 50 \text{ V}$	-9.8	-5	-2.1	mA
Control pin voltage	VC(CNT)	$VD = 5 \text{ V}$	5.3	5.9	6.5	V
Control pin voltage hysteresis *	$\Delta VC(\text{CNT})$	$VD = 5 \text{ V}$		10		mV
Circuit protections						
Self protection current limit	ILIMIT	Duty = 30% * Fig. 1, 2	0.73	0.8	0.87	A
ILIMIT modified coefficient	R_slope	$VC = VC(\text{CNT}) - 0.2 \text{ V}$ * Fig. 1, 2		30		mA/ μs
Leading edge blanking delay *	ton(BLK)		240	300	360	ns
Current limit delay *	td(OCL)		140	210	280	ns
Thermal shutdown temperature *	TOTP		130	140	150	$^\circ\text{C}$
Thermal shutdown temperature hysteresis *	ΔTOTP			70		$^\circ\text{C}$
Output						
Power-up reset threshold voltage *	VCreset		1.8	2.6	3.5	V
ON-state resistance	RDS(ON)	$ID = 0.2 \text{ A}$		8	10	Ω
OFF-state leakage current	IDSS	$VD = 650 \text{ V}$, $VC = 6.5 \text{ V}$		10	20	μA
Breakdown voltage	VDSS	$ID = 100 \mu\text{A}$, $VC = 6.5 \text{ V}$	700			V
Rise time	tr	$VC = VC(\text{CNT}) - 0.2 \text{ V}$, $VD = 5 \text{ V}$ * Fig. 3		140		ns
Fall time	tf	$VC = VC(\text{CNT}) - 0.2 \text{ V}$, $VD = 5 \text{ V}$ * Fig. 3		30		ns
Supply voltage characteristics						
Drain supply voltage	VD(MIN)	$S1 = \text{OPEN}$	36			V

Note) *: Design guaranteed item

■ Electrical Characteristics (continued) $T_C = 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$

1. Measurement circuit



2. Figure 1. Measurement circuit 2

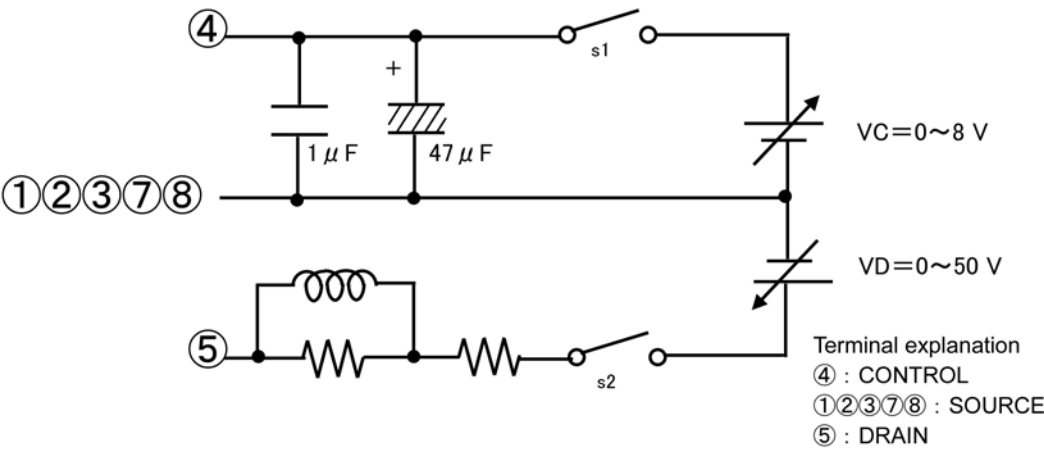
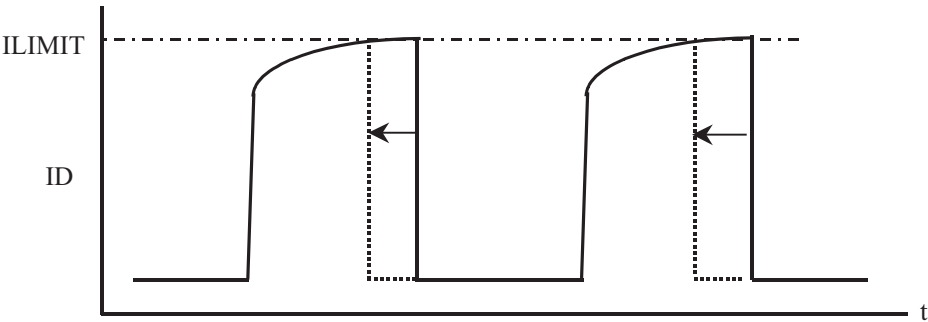


Figure 2. ILIMIT measurement



$$R_{\text{slope}} = \{(\text{ILIMIT at Duty} = 30\%) - (\text{ILIMIT at Duty} = 20\%)\} / \{(\text{Ton at Duty} = 30\%) - (\text{Ton at Duty} = 20\%)\}$$

■ Electrical Characteristics (continued) $T_C = 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$

2. Figure 3. t_r, t_f measurement

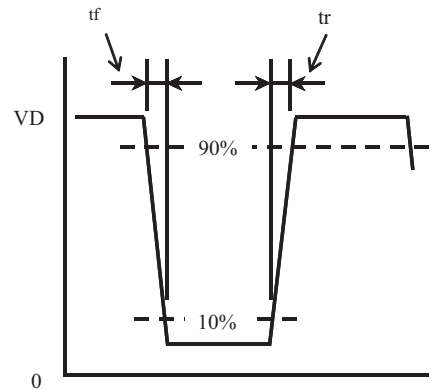


Figure 4. V_{C_m} , T_m , T_{TSW} , T_{TIM} , f_{TIM} measurement

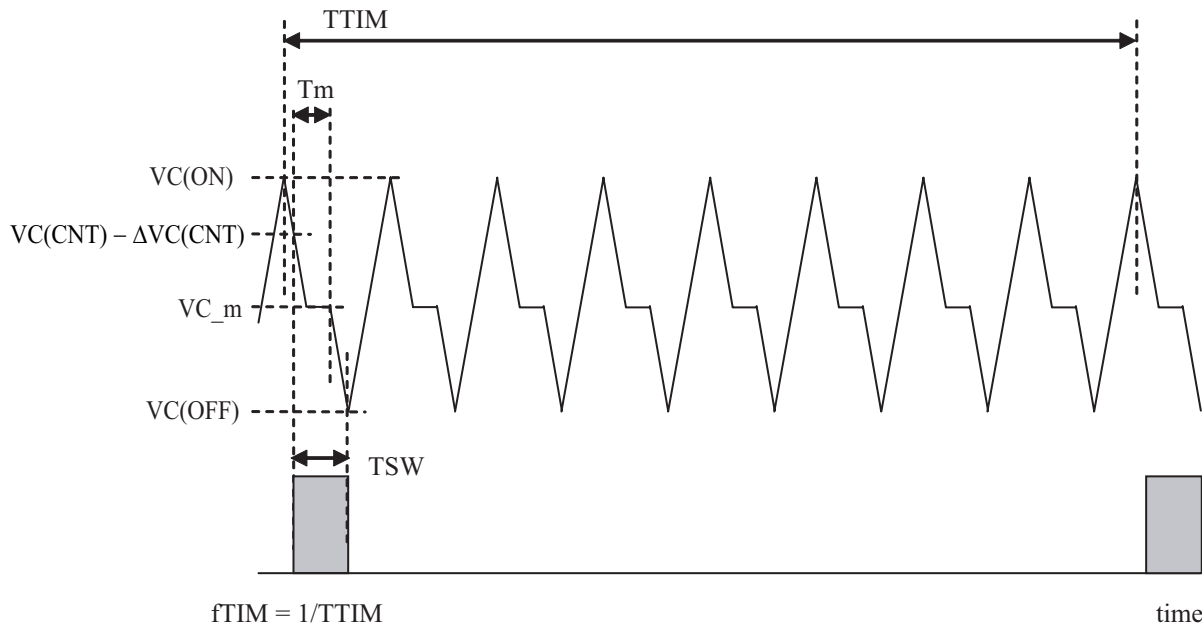
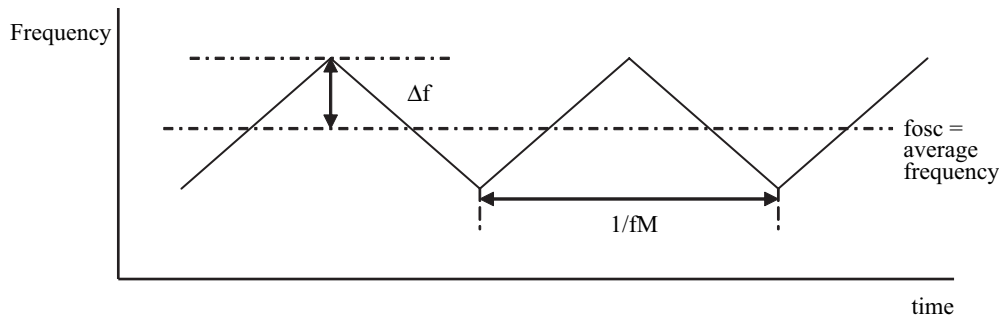


Figure 5. $\Delta f, f_M$ measurement



■ Usage Notes

Connect a Ceramic Capacitor (over 0.1 μ F) between CONTROL and SOURCE.

The IPD has risks for break-down or burst or giving off smoke in following conditions. Avoid the following use.

Fuse should be added at the input side or connect zener diode between control pin and GND, etc as a countermeasure to pass regulatory Safety Standard. Concrete countermeasure could be provided individually. However, customer should make the final judgment.

- (1) Reverse the DRAIN pin and SOURCE pin connection to the power supply board.
- (2) DRAIN pin short to CONTROL pin.
- (3) DRAIN pin short to SOURCE pin.

Request for your special attention and precautions in using the technical information and semiconductors described in this book

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Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- (7) This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of our company.

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- 1) The sale and/or the export of IPD products to customers located in certain countries is restricted by the Agreement made and executed by and between Power Integrations, Inc. and Panasonic Corporation. For details, refer to the following Attached table "IPD availability by customer."
- 2) IPD products purchased from our company, or its authorized agents, hereinafter referred to as our company, shall be used only for production purposes by those parties who have duly purchased IPD products. Those who have purchased IPD products shall not use such IPD products in unmodified form for re-sale, loan, or sample shipment for evaluation purposes to any other parties.
- 3) If a party who has duly purchased IPD products subcontracts its production to any other parties, including its subsidiaries or any other third parties inside and/or out of Japan, and the IPD products are consigned to such subcontracting parties thereat, such party is obligated to monitor and control the quantity of IPD products to prevent any of the aforementioned re-sale, loan or sample shipments from taking place.
- 4) In the event that any actual or threatened breach or violation of any of the above mentioned 2) or 3) has occurred or is about to occur, our company will hold all shipments of IPD products and may request the customer to disclose necessary documentation describing the status of our end-users and/or distribution channels.

Note) The products of MIP50**, MIP51**, and MIP7** are excluded from above-mentioned precautions, 1) to 3).

Attached table "IPD availability by customer"

Parts No.			Companies/areas to which products can be sold	Companies/areas to which products cannot be sold	Application
MIP01** MIP2** MIP9A**	MIP02** MIP3** MIP9L**	MIP1** MIP4**	· Japanese companies in Japan · Japanese companies in Asia (50% or more owned)	· Companies in European and American countries · Asian companies in Asia · Other local companies	· For power supply · For DC-DC converter
MIP00** MIP55** MIP816/826	MIP52** MIP56** MIP9E**	MIP53** MIP803/804	· Japanese companies in Japan · Japanese companies in Asia (50% or more owned) · Asian companies in Asia	· Companies in European and American countries · Other local companies	· For power supply · For EL driver · For LED lighting driver
MIP50**	MIP51**	MIP7**	· No restrictions in terms of contract	· No restrictions in terms of contract	· For lamp driver/ car electronics accessories

Note) For details, contact our sales division.